



DS34S132GN+Information

Heisener.com

Part Number DS34S132GN+
Manufacturer Maxim Integrated
Category Integrated Circuits (ICs)
Interface - Telecom

Description IC TDM OVER PACKET 676-BGA

Package 676-BGA

For the pricing/inventory/lead time, please contact

us

For Reference Only

Website: https://www.heisener.com
E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









DS34S132GN+ Specifications

Manufacturer Part Number	DS34S132GN+
Manufacturer	Maxim Integrated
Category	Integrated Circuits (ICs)
	Interface - Telecom
Package	676-BGA
Series	-
Function	TDM-over-Packet (TDMoP)
Interface	TDMoP
Number of Circuits	1
Voltage - Supply	1.8V, 3.3V
Current - Supply	-
Power (Watts)	-
Operating Temperature	-40°C ~ 85°C
Mounting Type	Surface Mount
Package / Case	676-BGA
Supplier Device Package	676-PBGA (27x27)
	Report errors?

DS34S132GN+ Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

DS34S132GN+ Payment Methods



















DS34S132GN+ Shipping Methods













If you have any question about DS34S132GN+, please do not hesitate to contact us!

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